

# BigTwin SuperServer SYS-222BT-HNC9R

2U 4-Node BigTwin with 6 hot-swap 2.5" NVMe/SAS/SATA drives per node



More details here

## Key Applications

Mission Critical HPC, Virtualized Big Data Analytics, High-Density Storage RAID Array,

## Key Features

- Four **hot-pluggable** systems (nodes) in a 2U form factor. Each node supports the following:;
- Dual Socket E2 Intel® Xeon® 6700/6500 series processors with P-cores or 6700 series processors with E-cores up to 205W with air cooling or 350W with liquid cooling  
Single CPU configurations supported while maintaining all expansion slot functionality; see Option A for drive support limitations;
- Up to 16 DIMMs supporting up to 4TB DDR5-6400 in 1DPC;
- Flexible networking with OCP 3.0 AIOM slot;
- 1 PCIe 5.0 x16 LP slots  
Internal PCIe 5.0 for 2 NVMe M.2 support onboard  
Optional 4 NVMe M.2 support onboard with built-in HW RAID1 via SCC-A2NM2241GH-B1;
- Up to 6 front hot-swap 2.5" NVMe/SAS drive bays  
Built-in SAS3 Support and RAID Options via Broadcom 3908; IR Mode;

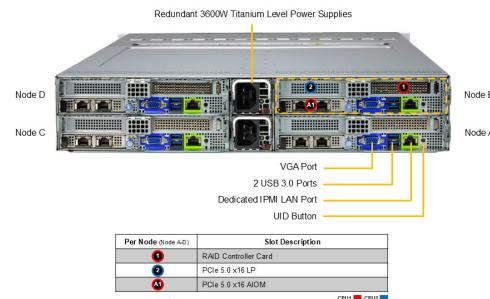


Form Factor	2U Rackmount Enclosure: 449 x 88 x 730mm (17.68" x 3.47" x 28.75") Package: 626 x 248 x 1150mm (24.65" x 9.76" x 45.28")
Processor	Dual Socket E2 (LGA-4710) Intel® Xeon® 6700/6500 series processors with P-cores or 6700 series processors with E-cores P-cores: Up to 86C/172T; Up to 336MB Cache per CPU E-cores: Up to 144C/144T; Up to 108MB Cache per CPU
System Memory	Slot Count: 16 DIMM slots Max Memory (1DPC): Up to 4TB 6400MT/s ECC DDR5 RDIMM
Drive Bays Configuration	Default: Total 6 bays <ul style="list-style-type: none"> <li>• 2 front hot-swap 2.5" PCIe 5.0 NVMe/SAS drive bays</li> <li>• 4 front hot-swap 2.5" PCIe 4.0 NVMe/SAS drive bays</li> </ul> M.2: 2 M.2 PCIe 5.0 x4 NVMe slots (M-key 22110(default); VROC required for RAID)
Expansion Slots	Default <ul style="list-style-type: none"> <li>• 1 PCIe 5.0 x16 LP slot</li> <li>• 1 PCIe 5.0 x16 AIOM slot (OCP 3.0 compatible)</li> </ul>
On-Board Devices	SAS: SAS (12Gbps) via Broadcom® 3908; RAID 0/1/5/10 support(IR mode) Chipset: System on Chip Network Connectivity: Via AIOM
Input / Output	LAN: 1 RJ45 1 GbE Dedicated BMC LAN port USB: 2 USB 3.0 Gen2 Type-A ports(Rear) Video: 1 VGA port

(Front View - System)



(Rear View - System)

**System Cooling**

Fans: Up to 4x 16K RPM Counter Rotating 80x80x56mm Fan(s)  
 Air Shroud: 4 Air Shrouds  
 Liquid Cooling: Direct to Chip (D2C) Cold Plate (optional)

**Power Supply**

2x 3600W Redundant (1 + 1) Titanium Level (96%) power supplies

**System BIOS**

BIOS Type: AMI 32MB Flash ROM

**Management**

SuperCloud Composer®; Supermicro Server Manager (SSM); Super Diagnostics Offline (SDO); Supermicro Thin-Agent Service (TAS); SuperServer Automation Assistant (SAA) New!

**PC Health Monitoring**

FAN: Fans with tachometer monitoring  
 Status monitor for speed control  
 Pulse Width Modulated (PWM) fan connectors  
 Temperature: Monitoring for CPU and chassis environment  
 CPU: Monitors for CPU Cores, Chipset Voltages, Memory.  
 8+4 Phase-switching voltage regulator

**Dimensions and Weight**

Weight: Gross Weight: 96.6 lbs (43.8 kg)  
 Net Weight: 66.1 lbs (30 kg)  
 Available Color: Black front & silver body

**Operating Environment**

RoHS Compliant  
 Operating Temperature: 10°C to 35°C (50°F to 95°F)  
 Non-operating Temperature: -30°C to 60°C (-22°F to 140°F)  
 Operating Relative Humidity: 8% to 80% (non-condensing)  
 Non-operating Relative Humidity: 8% to 90% (non-condensing)

**Motherboard**

[\*\*Super X14DBT-B\*\*](#)

**Chassis**

**CSE-217BQ2-R3K60P**